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TW	2001/055146	12/2001	Atobe et al.				
TW	2002/195673	12/2002	Chou et al.				
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/Tina Wong/

12/15/2006

Examiner: /Tina Wong/ Date Considered: 12/15/2006

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- 6 V	·	J.S. PATI	ENT DOCUMENTS		•			
Examiner	Document No.	Date	Name		Class	Sub		
TM	2003/0107794	06/2003	Siekkinen et al.					
m	6,525,864	02/2003	Gee et al.					
m	. 6,449,079	09/2002	Herrmann		·			
m	6,291,317	09/2001	Salatino et al.					
74	5,923,995	07/1999	Kao et al.		·			
M	5,721,162	02/1998	Schubert et al.					
7			·	•			·	
	FOREI	GN PATE	ENT DOCUMENT				Tra	ans
Examiner	Document No.	Date	Country		Class	Sub	Y	N
Examiner		04/1994	Japan		Ç1033	500	广	X
TM	(with English abstract)		•		-			
m	08-106614 (with English abstract)	04/1996	Japan '					х
	OTHER BOOK MENTS	(Includin	a Author Tidle Date Porting	nt Dogge	Ric \			
	Graph of cure time vs. glass	transition	g Author, Title, Date, Pertine n temperature for BCB (date	unknowi) 1)			
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m			uctural Characterization of Sil , Materials Research Society.	Symp. \		pp. FFS	.12.	1-
	4010			<u> </u>				

Examiner: Date Considered: 05/2005

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INFORMATION DISCLOSURE CITATION

 Docket:
 015559-288
 Appln. No.:
 10/620,119

 Applicant:
 Thomas Wiegele et al.

 Filed:
 July 15, 2003
 Group:
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MAY O 3 TOOL &	OTHER DOCUMENTS	(Includin	g Author, Title, Dat	e, Pertinent Page	s, Etc.)	
CATENTA TOP	F. Niklaus, et al., "Low-Ten Microelectromechanical Sys	items, Vo	1. 10, No. 4, pp. 525	5-531 (12/2001)		
a.	F. Niklaus, et al., "Void-Fre Systems, Royal Institute of" Applicants admit the status of this application, but other prior art.	Fechnolog of this pu	gy, Stockholm, Swe blication as prior an	den (date unknot for the limited p	wn) ourpose of e	xamination
m_	S.K. Sampath, et al., "Rapid Ion Etching," IEEE (2001)	MEMS I	Prototyping using S		ling and De Move	
W_	A. Jourdain, et al., "Investig (RF-)MEMS Devices," IEE				ies for Hou	
m	T-K. Chou et al., "3D MEM Benzocyclobutene (BCB)," Actuators, Munch, Germany	The 11 th] (6/2001	International Confe	rence on Solid-S	ate Sensors	and
m	J. Neysmith et al., "A Modu and Processing," The Intern No. 4, pp. 474-480 (2000)	lar, Chip ational Jo	Scale, Direct Chip ournal of Microcircu	its and Electroni	ackage: And Company of the Company o	g, Vol. 23,
u	P.V. Dressendorfer, et al., " International Conference on	High-De	ensity Interconnect a	ınd System Pack	aging (200	o) No grant
M	Product literature entitled "(BCB) - Processing Procedu Develop Process," CYCLO	res for C	yclotene 4000 Serie	s (Photo BCB R	esins DS21	00 Puddle
m	Product literature entitled "(BCB) – Processing Procedu Develop Process," CYCLO	res for C'TENETM	YCLOTENE TM 400 Advanced Electroni	O Series Photo B c Resins, by Do	CB Resins v (revised	- Immersion 4/02/2001)
m	Product literature entitled "(Resins," CYCLOTENE TM Applicants admit the status of this application, but othe prior art.	dvanced of this pu	Electronic Resins, blication as prior as	by Dow (date un t for the limited	ıknown) purpose of (examination
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Ų	MAY 0 3 AUG		(Including Author, Title, Date, Pertin					
\	COLUMN TOP		umary Study of BCB Coating Tests," by EVG (date unknown) of this publication as prior art for the limited purpose of examination					
	-M_	of this application, but other prior art.	wise reserve the right to challenge the status of this publication as					
(date of first publication u Applicants admit the statu			Flip Chi;p: What, Why, How," web cnown). of this publication as prior art for the l wise reserve the right to challenge the	limited purpose of examination				
•	m		face Mountable Chip Size Packaging 1 Components VI, Proceedings of SPI					
	m	(MEMS)," Microsystem Te	inges in microelectronics and micro el chnologies, 7, pp. 151-154 (2001)	No ment				
	m		ces in Dicing Wafers for Micro Electroume 2, MICRO.tec 2000, Hanover Ge					

Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609.

Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.